

C1808C331J5GALTU

Aliases (C1808C331J5GAL7800)

SMD Comm COG SnPb, Ceramic, 330 pF, 5%, 50 VDC, COG, SMD, MLCC, Ultra-Stable, Low Loss, Class I, 1808, 2.9 mm



Click [here](#) for the 3D model.

General Information

Series	SMD Comm COG SnPb
Style	SMD Chip
Description	SMD, MLCC, Ultra-Stable, Low Loss, Class I
Features	Ultra-Stable, Low Loss, Class I
RoHS	No
Prop 65	WARNING: Cancer and reproductive harm - https://www.p65warnings.ca.gov/
SCIP Number	5549986b-60cf-4a2a-afbb-4ad1d7a1dcb
Termination	Lead (SnPb)
Marking	No
AEC-Q200	No
Typical Component Weight	62 mg
Shelf Life	78 Weeks
MSL	1

Dimensions

Chip Size	1808
L	4.7mm +/-0.5mm
W	2mm +/-0.2mm
T	1mm +/-0.15mm
S	2.9mm MIN
B	0.6mm +/-0.35mm

Packaging Specifications

Packaging	T&R, 180mm, Plastic Tape
Packaging Quantity	2500

Specifications

Capacitance	330 pF
Measurement Condition	1 MHz 1.0Vrms
Tolerance	5%
Voltage DC	50 VDC
Dielectric Withstanding Voltage	125 VDC
Temperature Range	-55/+125°C
Temp. Coefficient	COG
Capacitance Change with Reference to +25°C and 0 VDC Applied (TCC)	30 ppm/C, 1MHz 1.0Vrms
Dissipation Factor	0.1% 1 MHz 1.0Vrms
Aging Rate	0% Loss/Decade Hour
Insulation Resistance	100 GOhms

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